_ form: A4mmXLc 1	 61083-□□□□□ NUMBER OF POSITIONS 06 2.X20 06 2.X50 16 2.X60 16 2.X60 16 2.X60 16 2.X60 16 2.X60 16 2.X80 FOR COMBINATION OF MATED HEIGHT, 16 2.X80 FOR COMBINATION OF MATED HEIGHT, 14 2.X60 FOR COMBINATION OF MATED HEIGHT, 2. PLATING: 2. PLATING: 3. SEE GS-12-547 FOR PRODUCT SPECIFICATION. 3. SEE GS-12-547 FOR PRODUCT SPECIFICATION. 3. SEE GS-12-547 FOR PRODUCT SPECIFICATION. 3. SEE GS-14-551 AND GS-14-816 FOR PACKAGING SPECIFICATION. 5. PACKING OPTION 2: NOT ALL SIZES XANLABLE; CHECK WITH FACTORY' (6) ONLY PLUG 1: 80 POSITIONS AVAILABLE. PLUG 4: 120 POSITIONS AVAILABLE. (7) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULTATIONS AS ESCRIBED IN CS-22-000 VAPOR PHASE REFLOW OVEN. 8. THE HOUSING WILL WITHSTAND EXPOSSIVE TO 260°C PEAK TEMPERATURE F SECONDS IN A CONVETTION, INFRA-RED GN VAPOR PHASE REFLOW OVEN. (9) PLATING OPTION 'A' IS LEADFREE ALTERNATIVE FOR OPTION 'O, AND OPT S LEADFREE ALTERNATIVE FOR OPTION 'I'. 10. A △ SYMBOL WILL BE NEXT TO ANY DIMENSION, NOTE OR VIEW WHICH H WODIFIED WITH THE CURRENT DRAMING REVISION. 	Copyright FCI.
2	IGHT, SEE DWG.NO. IGHT, SEE DWG.NO. URE FOR 10 OPTION '6' IGHT AS BEEN) FC
3	PACKAGING 0 TUBE WITHOUT CAP 9 TUBE WITHOUT CAP 9 TUBE WITH CAP 9 TUBE WITH CAP 1 TRAY WITH CAP 1 PLATING ON CONTACT AREA 0 YES 1 PLATING ON CONTACT AREA 0 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 WITH GOLD 0.2 um MIN. / TIN LEAD SOLDER 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN 4 NICKEL UNDERPLATE OVERALL 1.27 um MIN 4 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN 4 NICKEL UNDERPLATE OVERALL 1.27 um MIN 1 NICKEL UNDERPLATE OVERALL 1.27 um MIN	2
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